



# Nelco® N4000-13 EP™ Nelco® N4000-13 EP™ SI®



## High-Speed Multifunctional Epoxy Laminate & Prepreg

Nelco® N4000-13 EP™ is an enhanced epoxy resin system engineered for today's lead-free requirements where multiple solder reflow at temperatures approaching 260°C are required. N4000-13 EP provides enhanced thermal reliability without compromising the electrical and signal loss properties that have made the Nelco® N4000-13 product family the industry standard for demanding high speed / low loss designs. The N4000-13 EP™ SI® is excellent for applications that require optimum signal integrity and precise impedance control, while maintaining high CAF resistance and thermal reliability.

### Key Features

#### Tg >210°C, outstanding thermal, electrical and signal loss properties

- Excellent thickness control for tight tolerance impedance applications
- Low Df and Dk allows for low signal distortion and faster signal propagation required by high frequency (1 - 10 GHz) and high reliability applications

#### CAF resistant

- The low Z-CTE and improved CAF resistance provide long-term reliability for both RF and digital applications
- Provides excellent CAF resistance even after multiple lead-free assembly exposures

#### Signal Integrity Option

- SI® glass available for low-loss applications and enhanced performance

#### Proprietary advanced resin technology

- Industry standard material with well documented dielectric constant and loss tangent properties

#### High-Tg FR-4 processing

- Identical processing to Nelco® N4000-13, similar to traditional high Tg FR-4 materials
- 90 min press at 193°C and 275-350 psi

#### Lead-Free Assembly Compatible

- Suitable for assemblies with a maximum reflow temperature of 260°C<sup>1</sup>

#### Available in a variety of constructions

- Available in a wide variety of constructions, copper weights and glass styles including very low profile copper, standard copper, double treat and RTFOIL®
- Available as a 2 mil core product meeting the specifications of a capacitive laminate
- Meets UL 94V-0 and IPC-4101/29 specifications
- All of Park's electronic materials are RoHS compliant

### Applications

- Fine-Line Multilayers
- Backplanes
- Surface-Mount Multilayers
- BGA Multilayers
- MCM-Ls
- CSP Attachment
- Wireless Communication Infrastructure
- High Speed Services
- High Speed Storage Networks
- Internet Switching / Routing Systems

<sup>1</sup> Max suitable reflow temperature for N4000-13 EP assemblies is dependent upon design and fabrication details.

# Nelco® N4000-13 EP™ / N4000-13 EP™ SI®

## High-Speed Multifunctional Epoxy Laminate & Prepreg

	-13 EP	-13 EP SI®	U.S. Units	-13 EP	-13 EP SI®	Metric	Test Method
<b>Mechanical Properties</b>							
Peel Strength - 1 oz. (35 micron) Cu							
After Solder Float	7.5	7.5	lb / inch	1.31	1.31	N / mm	IPC-TM-650.2.4.8
At Elevated Temperature	8.1	8.1	lb / inch	1.42	1.42	N / mm	IPC-TM-650.2.4.8.2a
After Exposure to Process Solutions	9.0	9.0	lb / inch	1.58	1.58	N / mm	IPC-TM-650.2.4.8
X / Y CTE [-40°C to +125°C]				10 - 14	9 - 13	ppm / °C	IPC-TM-650.2.4.41
Z Axis CTE Alpha 1 [50°C to Tg]				65	65	ppm / °C	IPC-TM-650.2.4.24
Z Axis CTE Alpha 2 [Tg to 260°C]				275	275	ppm / °C	IPC-TM-650.2.4.24
Z Axis Expansion [50°C to 260°C]	3.4	3.4	%	3.4	3.4	%	IPC-TM-650.2.4.24
Young's Modulus (X / Y)	4.2 / 3.3	2.5 / 2.3	psi x 10 <sup>6</sup>	28.5 / 22.4	17.2 / 16.5	GN / m <sup>2</sup>	ASTM D3039
Poisson's Ratios (X / Y)	0.13 / 0.11	0.18 / 0.17		0.13 / 0.11	0.18 / 0.17		ASTM D3039
Thermal Conductivity				0.350	0.294	W / mK	ASTM E1461
Specific Heat				1.20	1.30	J / gK	ASTM E1461
<b>Electrical Properties</b>							
Dielectric Constant (50% resin content)							
@ 1 GHz (RF Impedance)	3.7	3.4		3.7	3.4		IPC-TM-650.2.5.5.9
@ 2.5 GHz (Split Post Cavity)	3.7	3.2		3.7	3.2		
@ 10 GHz (Stripline)	3.6	3.2		3.6	3.2		IPC-TM-650.2.5.5.5
@ 10 GHz (Split Post Cavity)	3.7	3.3		3.7	3.3		
Dissipation Factor (50% resin content)							
@ 2.5 GHz (Split Post Cavity)	0.009	0.008		0.009	0.008		
@ 10 GHz (Stripline)	0.009	0.008		0.009	0.008		IPC-TM-650.2.5.5.5
@ 10 GHz (Split Post Cavity)	0.008	0.007		0.008	0.007		
Volume Resistivity							
C - 96 / 35 / 90				10 <sup>8</sup>	10 <sup>8</sup>	MΩ - cm	IPC-TM-650.2.5.17.1
E - 24 / 125				10 <sup>7</sup>	10 <sup>8</sup>	MΩ - cm	IPC-TM-650.2.5.17.1
Surface Resistivity							
C - 96 / 35 / 90	10 <sup>7</sup>	10 <sup>7</sup>	MΩ	10 <sup>7</sup>	10 <sup>7</sup>	MΩ	IPC-TM-650.2.5.17.1
E - 24 / 125	10 <sup>7</sup>	10 <sup>7</sup>	MΩ	10 <sup>7</sup>	10 <sup>7</sup>	MΩ	IPC-TM-650.2.5.17.1
Electric Strength	1200	1000	V / mil	4.7x10 <sup>4</sup>	3.9x10 <sup>4</sup>	V / mm	IPC-TM-650.2.5.6.2
Dielectric Breakdown	>50	>50	kV	>50	>50	kV	IPC-TM-650.2.5.6
Arc Resistance	123	123	seconds	123	123	seconds	IPC-TM-650.2.5.1
<b>Thermal Properties</b>							
Glass Transition Temperature (Tg)							
DSC (°C)	210	210	°C	210	210	°C	IPC-TM-650.2.4.25c
TMA (°C)	200	200	°C	200	200	°C	IPC-TM-650.2.4.24c
DMA (°C) (Tan d Peak)	240	240	°C	240	240	°C	IPC-TM-650.2.4.24.3
Degradation Temp (TGA) (5% wt. loss)	350	350	°C	350	350	°C	IPC-TM-650.2.4.24.6
Pressure Cooker-60 min then solder dip							IPC-TM-650.2.6.16
@288°C until failure (max 10 min.)	Pass	Pass		Pass	Pass		(modified)
T260	30+	30+	minutes	30+	30+	minutes	IPC-TM-650.2.4.24.1
T288	10+	10+	minutes	10+	10+	minutes	IPC-TM-650.2.4.24.1
<b>Chemical / Physical Properties</b>							
Moisture Absorption	0.1	0.1	wt. %	0.1	0.1	wt. %	IPC-TM-650.2.6.2.1
Methylene Chloride Resistance	0.7	0.7	% wt. chg.	0.7	0.7	% wt. chg.	IPC-TM-650.2.3.4.3
Density [50% resin content]				1.91	1.79	g / cm <sup>3</sup>	Internal Method

All test data provided are typical values and not intended to be specification values. For review of critical specification tolerances, please contact a company representative directly.

\*Refer to the [N4000-13 Best Practices](#) document and [Contract Manufacturing Q&A](#) for PCB processing recommendations.

EP™, LD®, Mercurywave®, Meteorwave®, Nelco®, RTFoil® and SI® are trademarks of Park Electrochemical Corp.

### For Information about Park's materials:

North America +1.316.283.6500 • Europe +33.5.62.98.52.90 • Asia Pacific +65.686.17117  
[info@parkelectro.com](mailto:info@parkelectro.com) • [www.parkelectro.com](http://www.parkelectro.com)